

## TRADEMARK ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

ETAS ID: TM410251

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT		
<b>NATURE OF CONVEYANCE:</b>	RELEASE OF SECURITY INTEREST		
<b>CONVEYING PARTY DATA</b>			
<b>Name</b>	<b>Formerly</b>	<b>Execution Date</b>	<b>Entity Type</b>
Johnson Bank		12/23/2016	Corporation: WISCONSIN
<b>RECEIVING PARTY DATA</b>			
<b>Name:</b>	PACIFIC AEROSPACE & ELECTRONICS, INC.		
<b>Street Address:</b>	434 OLDS STATION ROAD		
<b>City:</b>	WENATCHEE		
<b>State/Country:</b>	WASHINGTON		
<b>Postal Code:</b>	98801		
<b>Entity Type:</b>	Corporation: WASHINGTON		
<b>PROPERTY NUMBERS Total: 7</b>			
<b>Property Type</b>	<b>Number</b>	<b>Word Mark</b>	
<b>Registration Number:</b>	1998984	HERMETIC ADVANTAGE	
<b>Registration Number:</b>	3488733	JUNIOR-D	
<b>Registration Number:</b>	3576279	LWP	
<b>Registration Number:</b>	3576280	LLWP	
<b>Registration Number:</b>	3717548	KRYOFLEX	
<b>Registration Number:</b>	3738316	ELECTRONIC PACKAGES FOR EXTREME ENVIRONM	
<b>Registration Number:</b>	3816192	PA&E	
<b>CORRESPONDENCE DATA</b>			
<b>Fax Number:</b>	2149813400		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>			
<b>Phone:</b>	214-981-3483		
<b>Email:</b>	dclark@sidley.com		
<b>Correspondent Name:</b>	Dusan Clark, Esq.		
<b>Address Line 1:</b>	Sidley Austin LLP		
<b>Address Line 2:</b>	2021 McKinney Ave., Suite 2000		
<b>Address Line 4:</b>	Dallas, TEXAS 75201		
<b>ATTORNEY DOCKET NUMBER:</b>	68262-10020		
<b>NAME OF SUBMITTER:</b>	Dusan Clark		
<b>SIGNATURE:</b>	/Dusan Clark/		

CH \$190.00 1998984

<b>DATE SIGNED:</b>	12/27/2016
<b>Total Attachments: 3</b> source=Releases#page3.tif source=Releases#page4.tif source=Releases#page5.tif	

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Trademark Holder: Pacific Aerospace & Electronics, Inc.  
Secured Party: Johnson Bank  
Reel/Frame No.: 5581/0769  
Date of Recordation of Security Interest: July 21, 2015

**Notice of Release of Security Interest in Trademarks**

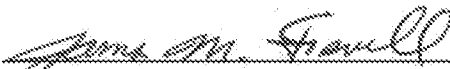
Commissioner for Trademarks  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

Notice is hereby given that the Secured Party terminates, releases and discharges any security interest in and lien upon the trademarks shown in the attached Schedule, and assigns, transfers, and conveys to the Trademark Holder any and all right, title or interest in, or to, the trademarks that the Secured Party may hold, without representation or warranty of any kind, express or implied, as of the date indicated below.

Respectfully submitted

Johnson Bank

By:   
Name: James M. Ferrell  
Title: Vice President  
Date: December 23, 2016

Certificate of Transmittal

I hereby certify that this correspondence is being electronically transmitted in PDF image format to the U.S. Patent and Trademark Office through the Electronic Trademark Assignment System (ETAS) on the date indicated below:

Date: \_\_\_\_\_, 2016 By: \_\_\_\_\_

Trademark Holder:  
 Secured Party:  
 Reel/Frame Nos.:  
 Date of Recordation of Security Interest

Pacific Aerospace & Electronics, Inc.  
 Johnson Bank  
 5581/0769  
 July 21, 2015

**SCHEDULE**

**U.S. Trademarks**

U.S. Trademark	Reg. No. / Ser. No.	Reg. / Filing Date	Goods / Services
HERMETIC ADVANTAGE	RN: 1998984 SN: 74521789	Registered: Sep. 10, 1996 Filed: May 3, 1994 Last Renewal: Sep. 10, 2006	(Int'l Class: 09) electronic components, namely electronic connectors and hermetic sealing devices
JUNIOR-D	RN: 3488733 SN: 78957018	Registered: Aug. 19, 2008 Filed: Aug. 21, 2006	(Int'l Class: 09) electronic connectors in the nature of hermetic sealing devices, namely, dc connectors having controlled coefficient of thermal expansion characteristics, unique chemical bonding properties, and comprising polycrystalline ceramic substances
LWP	RN: 3576279 SN: 78957032	Registered: Feb. 17, 2009 Filed: Aug. 21, 2006 Affidavit(s): 8 & 15, July 12, 2014	(Int'l Class: 09) electronic components, namely, electronic connectors and hermetic sealing devices, namely, rf connectors
LLWP	RN: 3576280 SN: 78957039	Registered: Feb. 17, 2009 Serial No.: 78-957039 Filed: Aug. 21, 2006 Affidavit(s): 8 & 15, July 12, 2014	(Int'l Class: 09) electronic components, namely, electronic connectors and hermetic sealing devices, namely, rf connectors
KRYOFLEX	RN: 3717548 SN: 77589387	Registered: Dec. 1, 2009 Serial No.: 77-589387 Filed: Oct. 9, 2008	(Int'l Class: 01) ceramic materials in the nature of powders for use in the manufacture of electronic components and devices, namely, hermetic connectors, integrated electronic packaging, electromagnetic interference filters, for use in defense, space, medical, aviation, energy, nuclear, marine, fiber optics, and communication industries

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ELECTRONIC PACKAGES FOR EXTREME ENVIRONMENTS	RN: 3738316 SN: 77244923	Registered: Jan. 12, 2010 Filed: Aug. 1, 2007 Register Type: Supplemental Register	(Int'l Class: 40) manufacture to the order and specification of others in the field of electronic components and devices, namely, integrated electronic packaging, hermetic connectors, non-hermetic connectors, rf connectors, microwave connectors, dc connectors, high pressure connectors, fiber optic connectors, hermetic windows, machined housings, electromagnetic interference filters, explosively bonded metals
PA&E	RN: 3816192 SN: 77589448	Registered: Jul. 13, 2010 Filed: Oct. 9, 2008	(Int'l Class: 09) electronic components and devices, namely, hermetic electronic connectors, integrated hermetic electronic packaging in the nature of protective features built into the electronic product, and electromagnetic interference filters for use in defense, space, medical, aviation, energy, nuclear, marine, fiber optics, and communication industries  (Int'l Class: 40) manufacturing of electronic components and devices to the order and specifications of others